

Special Issue

Selected Papers from IUMRS-ICEM 2018

Message from the Guest Editors

This Special Issue on "Selected Papers from IUMRS-ICEM 2018" is expected to select excellent papers presented at IUMRS-ICEM 2018 on electronic materials, 2D materials, soft electronics, functional materials, energy and energy storage, bio-engineering, and emerging advanced materials. We cordially invite researchers from the conference who would like to publish their original research articles in this Special Issue. Manuscripts are expected to be submitted through the online system at <http://susy.mdpi.com>, choosing journal "Applied Sciences" and Special Issue "Selected Papers from IUMRS-ICEM 2018". First-time users are required to register themselves before submitting.

Prof. Dr. Caroline Sunyoung Lee

Guest Editors

Prof. Sarah Eunkyung Kim

Prof. Dr. Caroline Sunyong Lee

Prof. Dr. Jihwan An

Prof. Dr. Jong-Sook Lee

Deadline for manuscript submissions

closed (30 September 2018)



Applied Sciences

an Open Access Journal
by MDPI

Impact Factor 2.5
CiteScore 5.5



mdpi.com/si/15332

Applied Sciences
Editorial Office
MDPI, Grosspeteranlage 5
4052 Basel, Switzerland
Tel: +41 61 683 77 34
applsci@mdpi.com

mdpi.com/journal/

[applsci](https://mdpi.com/journal/applsci)





Applied Sciences

an Open Access Journal
by MDPI

Impact Factor 2.5
CiteScore 5.5



[mdpi.com/journal/
applsci](https://mdpi.com/journal/applsci)



About the Journal

Message from the Editor-in-Chief

As the world of science becomes ever more specialized, researchers may lose themselves in the deep forest of the ever increasing number of subfields being created. This open access journal *Applied Sciences* has been started to link these subfields, so researchers can cut through the forest and see the surrounding, or quite distant fields and subfields to help develop his/her own research even further with the aid of this multi-dimensional network.

Editor-in-Chief

Prof. Dr. Giulio Nicola Cerullo
Dipartimento di Fisica, Politecnico di Milano, Piazza L. da Vinci 32,
20133 Milano, Italy

Author Benefits

Open Access:

free for readers, with article processing charges (APC) paid by authors or their institutions.

High Visibility:

indexed within Scopus, SCIE (Web of Science), Ei Compendex, Inspec, Embase, CAPIus / SciFinder, and other databases.

Journal Rank:

JCR - Q2 (Engineering, Multidisciplinary) / CiteScore - Q1 (General Engineering)